

TG-G3.0-01

Heatsink thermal paste grease, 3 g weight

- Keep your computer's CPU cool
- Practical syringe for easy application

Features

- Thermal compound (grease) for heatsinks
- Helps the heat dissipation from a CPU, chipset or processor to a heatsink
- Excellent thermal impedance
- Perfect stability will not separate, run, migrate, or bleed
- Non capacitive or electrically conductive

Packaging

Q'ty in crtn, pcs	100
Crtn volume, CUM	0.041
Crtn weight, kgs	3.34
Individual package size LxWxH:	180x120x15 mm
Carton size LxWxH:	390x380x280 mm
Country of origin	CN
Barcode	8716309083133
Customs code	3402909000

Specifications

Weight: 3.0 g
Color: gray
Thermal conductivity: > 4.5 W / mK
Thermal Impedance <0.205 ° C-in2 / W
Density: > 2.5
Evaporation: <0.001 %
Volatility: <0.005 %
The dielectric constant: > 5.1
Dissipation Factor: <0.005
Viscosity: 76 CPS
Thixotropic index: 310 ± 10 ° C
Operating Temperature: -50 ~ 240 ° C
Composites: 50% silicone compounds
Compounds: 30% of carbon
The compounds of metal oxides: 20%

Certificates

